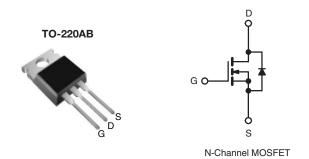


Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	400			
R _{DS(on)} (Ω)	V _{GS} = 10 V 0.55			
Q _g (Max.) (nC)	39			
Q _{gs} (nC)	10			
Q _{gd} (nC)	19			
Configuration	Single			



FEATURES

- Ultra Low Gate Charge
- Reduced Gate Drive Requirement
- Enhanced 30 V V_{GS} Rating
- Reduced C_{iss}, C_{oss}, C_{rss}
- Extremely High Frequency Operation
- Repetitive Avalanche Rated
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

This new series of low charge Power MOSFETs achieve significantly lower gate charge over conventional MOSFETs. Utilizing the new LCDMOS technology, the device improvements are achieved without added product cost, allowing for reduced gate drive requirements and total system savings. In addition, reduced switching losses and improved efficiency are achievable in a variety of high frequency applications. Frequencies of a few MHz at high current are possible using the new Low Charge MOSFETs.

These device improvements combined with the proven ruggedness and reliability that are characteristic of Power MOSFETs ofter the designer a new standard in power transistors for switching applications.

ORDERING INFORMATION			
Package	TO-220AB		
Lead (Pb)-free	IRF740LCPbF		
Leau (FD)-ilee	SiHF740LC-E3		
SnPb	IRF740LC		
SHED	SiHF740LC		

ABSOLUTE MAXIMUM RATINGS (TC	= 25 °C, unless otherwis	se noted)			
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage	V_{DS}	400	V		
Gate-Source Voltage		V_{GS}	± 30	7 v	
Continuous Drain Current	V_{GS} at 10 V $T_C = 25 ^{\circ}C$	I-	10	А	
Continuous Drain Current	T _C = 100 °C	I _D	6.3		
Pulsed Drain Current ^a	I _{DM}	32			
Linear Derating Factor		1.0	W/°C		
Single Pulse Avalanche Energy ^b	E _{AS}	520	mJ		
Repetitive Avalanche Currenta	I _{AR}	10	А		
Repetitive Avalanche Energy ^a	E _{AR}	13	mJ		
Maximum Power Dissipation $T_C = 25 ^{\circ}C$		P_{D}	125	W	
Peak Diode Recovery dV/dt ^c	dV/dt	4.0	V/ns		
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to + 150	°C		
Soldering Recommendations (Peak Temperature)		300 ^d			
Mounting Torque	6-32 or M3 screw		10	lbf ⋅ in	
Mounting rorque	0-02 OF IVIS SCIEW		1.1	N⋅m	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 9.1 mH, R_q = 25 Ω , I_{AS} = 10 A (see fig. 12).
- c. $I_{SD} \le 10 \text{ A}$, $dI/dt \le 120 \text{ A/}\mu\text{s}$, $V_{DD} \le V_{DS}$, $T_{J} \le 150 \,^{\circ}\text{C}$.
- d. 1.6 mm from case.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply

IRF740LC, SiHF740LC

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	62		
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50	-	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	1.0		

PARAMETER	SYMBOL	TEST (CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0$) V, I _D = 250 μA	400	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I _D = 1 mA	-	0.76	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V$	' _{GS} , I _D = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}	V _G	V _{GS} = ± 20 V		-	± 100	nA
Zoro Cata Valtago Drain Current		V _{DS} = 4	V _{DS} = 400 V, V _{GS} = 0 V		-	25	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 320 V, \	V _{GS} = 0 V, T _J = 125 °C	-	=.	250	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 6.0 A ^b	-	=	0.55	Ω
Forward Transconductance	9 _{fs}	V _{DS} = 5	60 V, I _D = 6.0 A ^b	3.0	=	-	S
Dynamic							
Input Capacitance	C _{iss}	V	' _{GS} = 0 V,	1	1100	-	
Output Capacitance	C _{oss}	V _I	_{DS} = 25 V,	1	190	-	pF
Reverse Transfer Capacitance	C_{rss}	f = 1.0	f = 1.0 MHz, see fig. 5		18	-	
Total Gate Charge	Q_g		$V_{GS} = 10 \text{ V}$ $I_D = 10 \text{ A}, V_{DS} = 320 \text{ V}$		-	39	
Gate-Source Charge	Q_{gs}	V _{GS} = 10 V			-	10	nC
Gate-Drain Charge	Q_{gd}		see fig. 6 and 13 ^b	-	-	19	1
Turn-On Delay Time	t _{d(on)}	$V_{DD} = 200 \text{ V, } I_D = 10 \text{ A },$ $R_g = 9.1 \Omega, R_D = 20 \Omega, \text{ see fig. } 10^b$		-	11	-	ns
Rise Time	t _r			-	31	-	
Turn-Off Delay Time	t _{d(off)}			-	25	-	
Fall Time	t _f			-	20	-	
Internal Drain Inductance	L _D	` ,	Between lead, 6 mm (0.25") from		4.5	-	mll
Internal Source Inductance	L _S	package and center of die contact		-	7.5	-	- nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		ı	-	10	
Pulsed Diode Forward Current ^a	I _{SM}			-	-	32	A
Body Diode Voltage	V_{SD}	T _J = 25 °C, I _S = 10 A, V _{GS} = 0 V ^b		-	-	2.0	V
Body Diode Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F = 10 A, dl/dt = 100 A/µs ^b		-	380	570	ns
Body Diode Reverse Recovery Charge	Q_{rr}			-	2.8	4.2	μC
Forward Turn-On Time	t _{on}	Intrinsic turn-	on is do	minated b	ov I e and	12)	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width \leq 300 µs; duty cycle \leq 2 %.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

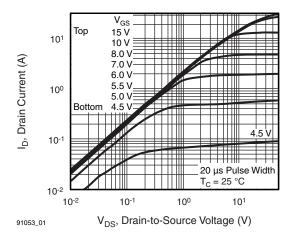
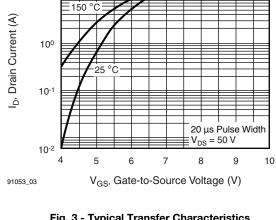


Fig. 1 - Typical Output Characteristics, T_C = 25 °C



10¹

Fig. 3 - Typical Transfer Characteristics

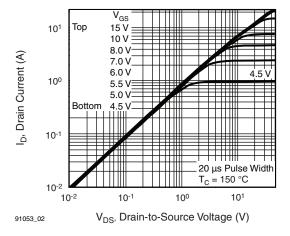


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

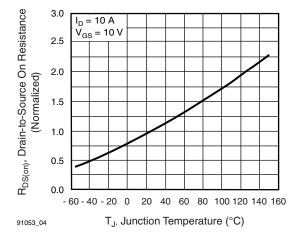


Fig. 4 - Normalized On-Resistance vs. Temperature

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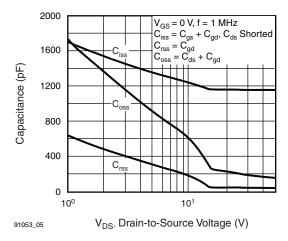


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

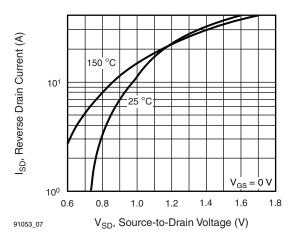


Fig. 7 - Typical Source-Drain Diode Forward Voltage

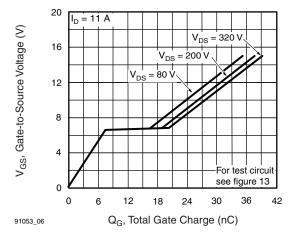


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

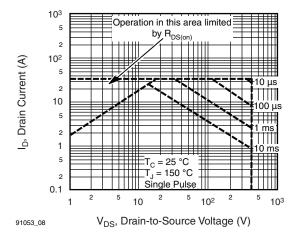


Fig. 8 - Maximum Safe Operating Area



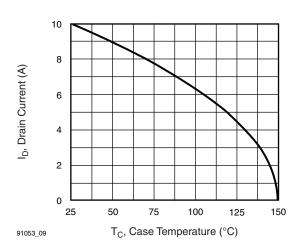


Fig. 9 - Maximum Drain Current vs. Case Temperature

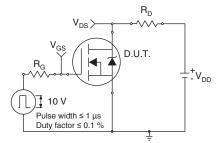


Fig. 10a - Switching Time Test Circuit



Fig. 10b - Switching Time Waveforms

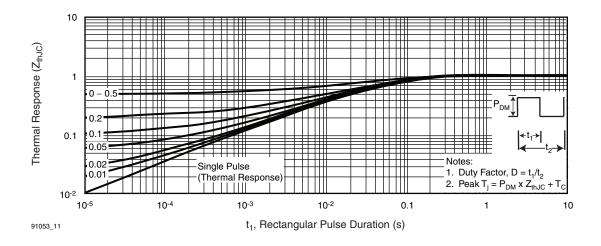


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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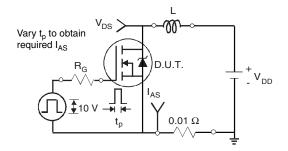


Fig. 12a - Unclamped Inductive Test Circuit

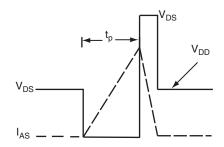


Fig. 12b - Unclamped Inductive Waveforms

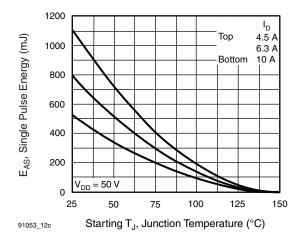


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

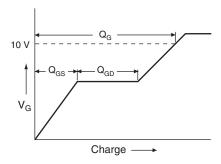


Fig. 13a - Basic Gate Charge Waveform

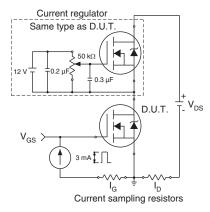
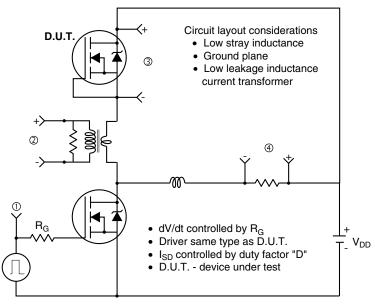
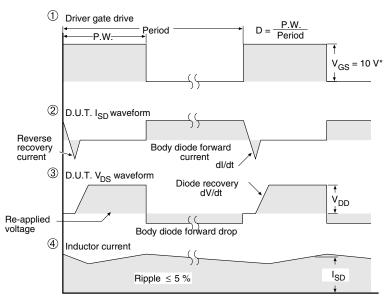


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit





* V_{GS} = 5 V for logic level devices

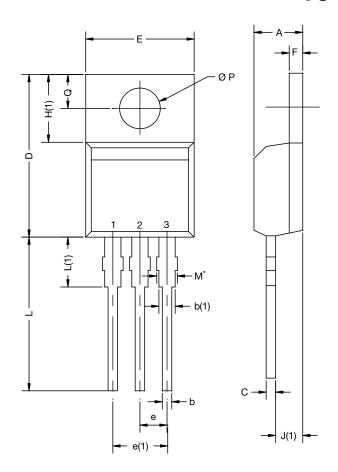
Fig. 14 - For N-Channel

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Document Number: 91053 S11-0507-Rev. B, 21-Mar-11



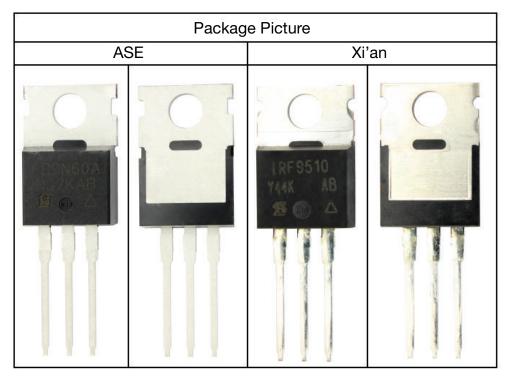
TO-220-1



DIM.	MILLIM	IETERS	INCHES		
DIIVI.	MIN.	MAX.	MIN.	MAX.	
Α	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
Е	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

 M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



Revison: 14-Dec-15 1 Document Number: 66542



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